# Universal Input Switchmode Controller 

FEATURES

- 10- to 450-V Input Range
- Current-Mode Control
- 125-mA Output Drive
- Internal Oscillator (1 MHz)
- SHUTDOWN and RESET


## DESCRIPTION

The Si9120 is a $\mathrm{BiC} / \mathrm{DMOS}$ integrated circuit designed for use in low-power, high-efficiency off-line power supplies. High-voltage DMOS inputs allow the controller to work over a wide range of input voltages (10- to 450-VDC). Current-mode PWM control circuitry is implemented in CMOS to reduce quiescent current to less than 1.5 mA .

A CMOS output driver provides high-speed switching for MOSFET devices with gate charge, $\mathrm{Q}_{\mathrm{g}}$, up to 25 nC , enough
to supply 30 W of output power at 100 kHz . These devices, when combined with an output MOSFET and transformer, can be used to implement single-ended power converter topologies (i.e., flyback and forward).

The Si9120 is available in both standard and lead (Pb)-free 16-pin plastic DIP and SOIC packages which are specified to operate over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

## FUNCTIONAL BLOCK DIAGRAM



[^0]
## ABSOLUTE MAXIMUM RATINGS

Voltages Referenced to $-\mathrm{V}_{\text {IN }}$ (Note: $\mathrm{V}_{\mathrm{CC}}<+\mathrm{V}_{\text {IN }}+0.3 \mathrm{~V}$ )


Logic Inputs (RESET
SHUTDOWN, OSC IN, OSC OUT) $\ldots . . . . . . . . .$.
Linear Input
(FEEDBACK, SENSE, BIAS, $\mathrm{V}_{\text {REF }}$ ) . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to 7 V
HV Pre-Regulator Input Current (continuous) ........................ . . 5 mA ${ }^{\text {a }}$
Continuous Output Current (Source or Sink) . . . . . . . . . . . . . . . . . . . 125 mA
Storage Temperature . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 65 to $150^{\circ} \mathrm{C}$
Operating Temperature .......................................... -40 to $85^{\circ} \mathrm{C}$
Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ ) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $150^{\circ} \mathrm{C}$

Power Dissipation (Package) ${ }^{\text {b }}$
16-Pin Plastic DIP (J Suffix) ${ }^{\text {c }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 750 mW
16-Pin SOIC (Y Suffix) ${ }^{\text {d }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 900 mW
Thermal Impedance ( $\Theta_{\mathrm{JA}}$ )
16-Pin Plastic DIP
$167^{\circ} \mathrm{C} / \mathrm{W}$
16-Pin SOIC .............................................................. . . $140^{\circ} \mathrm{C} / \mathrm{W}$

Notes
a. Continuous current may be limited by the applications maximum input voltage and the package power dissipation.
b. Device mounted with all leads soldered or welded to PC board.
c. Derate $6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $25^{\circ} \mathrm{C}$.
d. Derate $7.2 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $25^{\circ} \mathrm{C}$.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## RECOMMENDED OPERATING RANGE

Voltages Referenced to - $\mathrm{V}_{\text {IN }}$

| $\mathrm{V}_{\mathrm{CC}}$ | 9.5 V to 13.5 V | Rosc | $25 \mathrm{k} \Omega$ to $1 \mathrm{M} \Omega$ |
| :---: | :---: | :---: | :---: |
| + $\mathrm{V}_{\text {IN }}$ | 10 V to 450 V | Linear Inputs | 0 to $\mathrm{V}_{\mathrm{CC}}-3 \mathrm{~V}$ |
| $\mathrm{f}_{\text {OSc }}$ | 40 kHz to 1 MHz | Digital Inputs | 0 to $\mathrm{V}_{\mathrm{CC}}$ |


| SPECIFICATIONS ${ }^{\text {a }}$ |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Symbol | Specific Test Conditions$\begin{gathered} \text { DISCHARGE }=-\mathrm{V}_{\text {IN }}=0 \mathrm{~V}, \\ \mathrm{~V}_{\mathrm{CC}}=10 \mathrm{~V}+\mathrm{V}_{\text {IN }}=300 \mathrm{~V} \\ \mathrm{R}_{\mathrm{BIAS}}=390 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{OSC}}=330 \mathrm{k} \Omega \end{gathered}$ | TEMP ${ }^{\text {B }}$ | LIMITS <br> D Suffix - $\mathbf{4 0}$ to $\mathbf{8 5}{ }^{\circ} \mathbf{C}$ |  |  | Unit |
|  |  |  |  | MIN ${ }^{\text {C }}$ | TYPD | MAX ${ }^{\text {C }}$ |  |
| Reference |  |  |  |  |  |  |  |
| Output Voltage | $\mathrm{V}_{\mathrm{R}}$ | $\begin{gathered} \text { OSC IN }=-\mathrm{V}_{\text {IN }} \text { (OSC Disabled) } \\ R_{L}=10 \mathrm{M} \Omega \end{gathered}$ | Room Full | $\begin{aligned} & 3.88 \\ & 3.82 \end{aligned}$ | 4.0 | $\begin{aligned} & 4.12 \\ & 4.14 \end{aligned}$ | V |
| Output Impedance ${ }^{\text {e }}$ | $\mathrm{Z}_{\text {OUT }}$ |  | Room | 15 | 30 | 45 | k $\Omega$ |
| Short Circuit Current | IsREF | $\mathrm{V}_{\text {REF }}=-\mathrm{V}_{\text {IN }}$ | Room | 70 | 100 | 130 | $\mu \mathrm{A}$ |
| Temperature Stabilitye | TREF |  | Full |  | 0.5 | 1.0 | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ |
| Oscillator |  |  |  |  |  |  |  |
| Maximum Frequency ${ }^{\text {e }}$ | $\mathrm{f}_{\text {MAX }}$ | R ${ }_{\text {OSC }}=0$ | Room | 1 | 3 |  | MHz |
| Initial Accuracy | fosc | $\begin{gathered} \mathrm{C}_{\text {STRAY Pin } 9 \leq 5 \mathrm{pF}} \mathrm{p} \\ \text { RoSC }^{2} 330 \mathrm{k} \Omega \end{gathered}$ | Room | 80 | 100 | 120 | kHz |
|  |  | $\begin{gathered} \mathrm{C}_{\text {StRAY }} \text { Pin } 9 \leq 5 \mathrm{pF} \\ \mathrm{R}_{\text {OSC }}=150 \mathrm{k} \Omega \end{gathered}$ | Room | 160 | 200 | 240 |  |
| Voltage Stability | $\Delta \mathrm{f} / \mathrm{f}$ | $\Delta \mathrm{f} / \mathrm{f}=\mathrm{f}(13.5 \mathrm{~V})-\mathrm{f}(9.5 \mathrm{~V}) / \mathrm{f}(9.5 \mathrm{~V})$ | Room |  | 10 | 15 | \% |
| Temperature Coefficiente | Tosc |  | Full |  | 200 | 500 | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Error Amplifier |  |  |  |  |  |  |  |
| Feedback Input Voltage | $V_{\text {FB }}$ | $\begin{gathered} \text { FB Tied to COMP } \\ \text { OSC IN }=-\mathrm{V}_{\text {IN }} \text { (OSC Disabled) } \end{gathered}$ | Room | 3.92 |  | 4.08 | V |
| Input BIAS Current | $\mathrm{I}_{\text {FB }}$ | OSC IN = - $\mathrm{V}_{\text {IN }}, \mathrm{V}_{\mathrm{FB}}=4 \mathrm{~V}$ | Room |  | 25 | 500 | nA |
| Input OFFSET Voltage | $\mathrm{V}_{\text {OS }}$ | OSC IN $=-V_{\text {IN }}$ | Room |  | $\pm 15$ | $\pm 40$ | mV |
| Open Loop Voltage Gaine | Avol | OSC IN $=-\mathrm{V}_{\text {IN }}$ | Room | 60 | 80 |  | dB |
| Unity Gain Bandwidthe | BW | OSC IN = - $\mathrm{V}_{\text {IN }}$ | Room | 1.0 | 1.5 |  | MHz |

## SPECIFICATIONS ${ }^{\mathbf{a}}$



## Notes

a. Refer to PROCESS OPTION FLOWCHART for additional information.
b. Room $=25^{\circ} \mathrm{C}$, Cold and $\mathrm{Hot}=$ as determined by the operating temperature suffix.
c. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
d. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
e. Guaranteed by design, not subject to production test.
a. $\quad 250 \mathrm{~V} \leq+\mathrm{V}_{\text {IN }} 380 \mathrm{~V}$ place a $10-\mathrm{k} \Omega, 1 / 4-\mathrm{W}$ resistor in series with a $+\mathrm{V}_{\text {IN }}$ (Pin1).
$380 \mathrm{~V} \leq+\mathrm{V}_{\text {IN }} 450 \mathrm{~V}$ place a $15-\mathrm{k} \Omega, 1 / 4-\mathrm{W}$ resistor in series with a $+\mathrm{V}_{\text {IN }}$ (Pin1).
Connect a $0.01-\mu f d$ capacitor between $+\mathrm{V}_{\text {IN }}($ Pin 1$)$ and $-\mathrm{V}_{\text {IN }}($ Pin 6$)$.

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FIGURE 1.


FIGURE 2.


FIGURE 3.

TYPICAL CHARACTERISTICS


## PIN CONFIGURATIONS AND ORDERING INFORMATION



| ORDERING INFORMATION |  |  |
| :--- | :---: | :---: |
| Part Number | Temperature Range | Package |
| Si9120DY |  |  |
| Si9120DY-T1 | SOIC-16 |  |
| Si9120DY-T1-E3 |  |  |
| Si9120DJ |  |  |
| Si9120DJ-E3 |  |  | PDIP-16 |

## DETAILED DESCRIPTION

## Pre-Regulator/Start-Up Section

Due to the low quiescent current requirement of the Si9120 control circuitry, bias power can be supplied from the unregulated input power source, from an external regulated low-voltage supply, or from an auxiliary "bootstrap" winding on the output inductor or transformer.

When power is first applied during start-up, $+\mathrm{V}_{\text {IN }}$ (pin 1) will draw a constant current. The magnitude of this current is determined by a high-voltage depletion MOSFET which is connected between $+\mathrm{V}_{\mathrm{IN}}$ and $\mathrm{V}_{\mathrm{CC}}$ (pin 7). This start-up circuitry provides initial power to the IC by charging an external bypass capacitance connected to the $\mathrm{V}_{\mathrm{C}}$ pin. The constant current is disabled when $\mathrm{V}_{\mathrm{CC}}$ exceeds 8.6 V . If $\mathrm{V}_{\mathrm{CC}}$ is not forced to exceed the 8.6-V threshold, then $\mathrm{V}_{\mathrm{cc}}$ will be regulated to a nominal value of 8.6 V by the pre-regulator circuit.

As the supply voltage rises toward the normal operating conditions, an internal undervoltage (UV) lockout circuit keeps the output driver disabled until $\mathrm{V}_{\mathrm{CC}}$ exceeds the undervoltage lockout threshold (typically 8.1 V). This guarantees that the
control logic will be functioning properly and that sufficient gate drive voltage is available before the MOSFET turns on. The design of the IC is such that the undervoltage lockout threshold will be at least 300 mV less than the pre-regulator turn-off voltage. Power dissipation can be minimized by providing an external power source to $\mathrm{V}_{\mathrm{CC}}$ such that the constant current source is always disabled.

Note: When driving large MOSFETs at high frequency without a bootstrap $\mathrm{V}_{\mathrm{CC}}$ supply, power dissipation in the pre-regulator may exceed the power rating of the IC package. For operation of $+\mathrm{V}_{\text {IN }}>250 \mathrm{~V}$, a $10-\mathrm{k} \Omega, 1 / 4-\mathrm{W}$ resistor should be placed in series with $+\mathrm{V}_{\mathrm{IN}}$ (Pin 1 ). For $+\mathrm{V}_{\mathrm{IN}}>380 \mathrm{~V}$, a $15-\mathrm{k} \Omega, 1 / 4-\mathrm{W}$ resistor is recommended.

## BIAS

To properly set the bias for the Si 9120 , a $390-\mathrm{k} \Omega$ resistor should be tied from BIAS (pin 16) to $-\mathrm{V}_{\text {IN }}$ (pin 6). This determines the magnitude of bias current in all of the analog sections and the pull-up current for the SHUTDOWN and RESET pins. The current flowing in the bias resistor is nominally $15 \mu \mathrm{~A}$.

## DETAILED DESCRIPTION (CONT'D)

## Reference Section

The reference section of the Si9120 consists of a temperature compensated buried zener and trimmable divider network. The output of the reference section is connected internally to the non-inverting input of the error amplifier. Nominal reference output voltage is 4 V . The trimming procedure that is used on the Si9120 brings the output of the error amplifier (which is configured for unity gain during trimming) to within $\pm 2 \%$ of 4 V . This compensates for input offset voltage in the error amplifier.

The output impedance of the reference section has been purposely made high so that a low impedance external voltage source can be used to override the internal voltage source, if desired, without otherwise altering the performance of the device.

## Error Amplifier

Closed-loop regulation is provided by the error amplifier, which is intended for use with "around-the-amplifier" compensation. A MOS differential input stage provides for high input impedance. The noninverting input to the error amplifier $\left(\mathrm{V}_{\mathrm{REF}}\right)$ is internally connected to the output of the reference supply and should be bypassed with a small capacitor to ground.

## Oscillator Section

The oscillator consists of a ring of CMOS inverters, capacitors, and a capacitor discharge switch. Frequency is set by an external resistor between the OSC IN and OSC OUT pins. (See Typical Characteristics for details of resistor value vs. frequency.) The DISCHARGE pin should be tied to $-\mathrm{V}_{\mathrm{IN}}$ for normal internal oscillator operation. A frequency divider in the logic section limits switch duty cycle to $\leq 50 \%$ by locking the switching frequency to one half of the oscillator frequency.

## SHUTDOWN and RESET

SHUTDOWN (pin 12) and RESET (pin 13) are intended for overriding the output MOSFET switch via external control logic. The two inputs are fed through a latch preceding the output switch. Depending on the logic state of RESET. SHUTDOWN can be either a latched or unlatched input. The output is off whenever SHUTDOWN is low. By simultaneously having SHUTDOWN and RESET low, the latch is set and SHUTDOWN has no effect until RESET goes high. See Table TABLE 1

Both pins have internal current source pull-ups and should be left disconnected when not in use. An added feature of the current sources is the ability to connect a capacitor and an open-collector driver to the SHUTDOWN or RESET pins to provide variable shutdown time.

## TABLE 1.

TRUTH TABLE FOR SHUTDOWN AND RESET PINS

| SHUTDOWN | RESET | OUTPUT |
| :---: | :---: | :--- |
| H | H | Normal Operation |
| H | L | Normal Operation (No Change) |
| L | H | Off (Not Latched) |
| L | L | Off (Latched) |
| $\boldsymbol{\sim}$ | L | Off (Latched-No Change) |

## Output Driver

The push-pull driver output has a typical on-resistance of $20-\Omega$ maximum switching times are specified at 75 ns for a $500-\mathrm{pF}$ load. This is sufficient to directly drive MOSFETs such as the IRF820, BUZ78 or BUZ80. Larger devices can be driven, but switching times will be longer, resulting in higher switching losses.

[^1]SOIC (NARROW): 16-LEAD (POWER IC ONLY) JEDEC Part Number: MS-012


| $\operatorname{Dim}$ | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max |
| A | 1.35 | 1.75 | 0.053 | 0.069 |
| $\mathbf{A}_{\mathbf{1}}$ | 0.10 | 0.20 | 0.004 | 0.008 |
| B | 0.38 | 0.51 | 0.015 | 0.020 |
| C | 0.18 | 0.23 | 0.007 | 0.009 |
| D | 9.80 | 10.00 | 0.385 | 0.393 |
| E | 3.80 | 4.00 | 0.149 | 0.157 |
| $\mathbf{e}$ | 1.27 BSC | 0.050 BSC |  |  |
| H | 5.80 | 6.20 | 0.228 | 0.244 |
| L | 0.50 | 0.93 | 0.020 | 0.037 |
| $\varnothing$ | $0^{\circ}$ | $8^{\circ}$ | $0^{\circ}$ | $8^{\circ}$ |
| ECN: S-40080-Rev. A, 02-Feb-04 <br> DWG: 5912 |  |  |  |  |
|  |  |  |  |  |



## PDIP: 16-LEAD (POWER IC ONLY)



| Dim | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Min | Max | Min | Max |
| $\mathbf{A}_{\mathbf{1}}$ | 0.81 | 5.08 | 0.150 | 0.200 |
| $\mathbf{B}$ | 0.38 | 0.51 | 0.015 | 0.020 |
| $\mathbf{B}_{\mathbf{1}}$ | 0.89 | 1.65 | 0.035 | 0.065 |
| $\mathbf{C}$ | 0.20 | 0.30 | 0.008 | 0.012 |
| $\mathbf{D}$ | 18.93 | 21.33 | 0.745 | 0.840 |
| $\mathbf{E}$ | 7.62 | 8.26 | 0.300 | 0.325 |
| $\mathbf{E}_{\mathbf{1}}$ | 5.59 | 7.11 | 0.220 | 0.280 |
| $\mathbf{e}_{\mathbf{1}}$ | 2.29 | 2.79 | 0.090 | 0.110 |
| $\mathbf{e}_{\mathbf{A}}$ | 7.37 | 7.87 | 0.290 | 0.310 |
| $\mathbf{L}$ | 2.79 | 3.81 | 0.110 | 0.150 |
| $\mathbf{Q}_{\mathbf{1}}$ | 1.27 | 2.03 | 0.050 | 0.080 |
| $\mathbf{S}$ | 0.38 | 1.52 | .015 | 0.060 |
| ECN: S-40081-Rev. A, 02-Feb-04 |  |  |  |  |
| DWG: 5920 |  |  |  |  |

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NCP81203MNTXG NCP81206MNTXG NX2155HCUPTR UC3845ADM UBA2051C IR35201MTRPBF MAX8778ETJ+
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[^0]:    Applications information, see AN707 and AN708.

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